











PCM3070

SLAS724A - SEPTEMBER 2008 - REVISED NOVEMBER 2014

PCM3070 Stereo Audio Codec With Embedded miniDSP

Features

- Stereo Audio DAC with 100dB SNR
- Stereo Audio ADC with 93dB SNR
- Extensive Signal Processing Options
- Embedded miniDSP
- Six Single-Ended or 3 Fully-Differential Analog Inputs
- Stereo Headphone Outputs
- Stereo Line Outputs
- Very Low-Noise PGA
- Analog Bypass Mode
- Programmable PLL
- Integrated LDO
- 5 mm x 5 mm 32-Pin QFN Package

2 Applications

- Soundbar
- Flat Panel Television
- MP3 Docking stations
- Cell Phone Docking Stations
- Other Stereo or 2.1 Home Audio systems

Description

The PCM3070 is a flexible stereo audio codec with programmable inputs and outputs, programmable miniDSP, fixed predefined and parameterizable signal processing blocks, integrated PLL, integrated LDOs and flexible digital interfaces.

Device Information⁽¹⁾

| PART NUMBER | PACKAGE | BODY SIZE (NOM) |
|-------------|-----------|-------------------|
| PCM3070 | VQFN (32) | 5.00 mm x 5.00 mm |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

Simplified Schematic

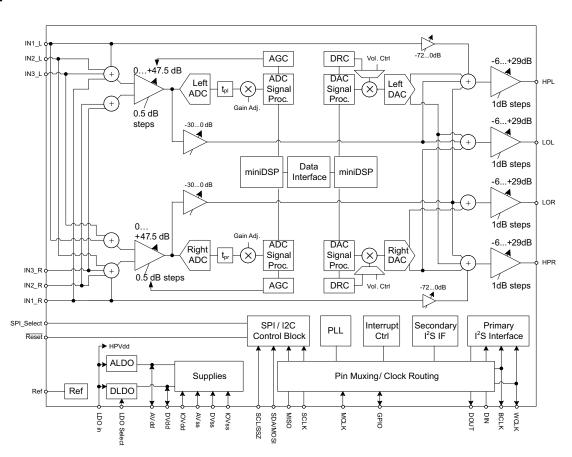




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5 Revision History

Changes from Original (February 2011) to Revision A

Page

Added Pin Configuration and Functions section, Handling Rating table, Feature Description section, Device
Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout
section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information
section

Product Folder Links: PCM3070

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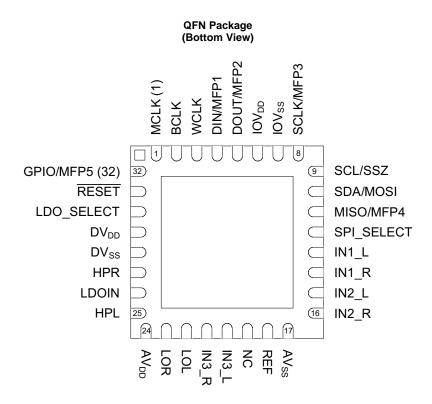
6 Device Comparison Table

| PART NUMBER | DESCRIPTION |
|-------------|--|
| PCM3070 | Stereo audio codec with embedded miniDSP |



7 Pin Configuration and Functions

This document describes signals that take on different names depending on how they are configured. In such cases, the different names are placed together and separated by slash (/) characters. For example, "SCL/SS". Active low signals are represented by overbars.



Pin Functions

| PIN | NAME | TYPE ⁽¹⁾ | DESCRIPTION |
|-----|-------------------|---------------------|---|
| 1 | MCLK | DI | Master Clock Input |
| 2 | BCLK | DIO | Audio serial data bus (primary) bit clock |
| 3 | WCLK | DIO | Audio serial data bus (primary) word clock |
| 4 | DIN | DI | Primary function: |
| | | | Audio serial data bus data input |
| | MFP1 | | Secondary function: |
| | | | General Purpose Clock Input |
| | | | General Purpose Input |
| 5 | DOUT | DO | Primary function: |
| | | | Audio serial data bus data output |
| | MFP2 | | Secondary function: |
| | | | General Purpose Output |
| | | | Clock Output |
| | | | INT1 Output |
| | | | INT2 Output Audio serial data bus (secondary) bit clock output |
| | | | Audio serial data bus (secondary) bit clock output Audio serial data bus (secondary) word clock output |
| 6 | IOV _{DD} | Power | IO voltage supply 1.1V – 3.6V |
| 7 | IOV _{SS} | Ground | IO ground supply |

(1) DI (Digital Input), DO (Digital Output), DIO (Digital Input/Output), AI (Analog Input), AO (Analog Output), AIO (Analog Input/Output)



Pin Functions (continued)

| PIN | NAME | TYPE ⁽¹⁾ | DESCRIPTION |
|-----|------------------|---------------------|---|
| 8 | SCLK | DI | Primary function: (SPI_Select = 1) |
| | / | | SPI serial clock |
| | MFP3 | | Secondary function: (SPI_Select = 0) |
| | | | Audio serial data bus (secondary) bit clock input Audio serial data bus (secondary) DAC or common word clock input Audio serial data bus (secondary) ADC word clock input Audio serial data bus (secondary) data input General Purpose Input |
| 9 | SCL/SS | DI | I ² C interface serial clock (SPI_Select = 0) SPI interface mode chip-select signal (SPI_Select = 1) |
| 10 | SDA/MOSI | DI | I ² C interface mode serial data input (SPI_Select = 0) SPI interface mode serial data input (SPI_Select = 1) |
| 11 | MISO | DO | Primary function: (SPI_Select = 1) |
| | / | | Serial data output |
| | MFP4 | | Secondary function: (SPI_Select = 0) |
| | | | General purpose output CLKOUT output INT1 output INT2 output Audio serial data bus (primary) ADC word clock output Audio serial data bus (secondary) data output Audio serial data bus (secondary) bit clock output Audio serial data bus (secondary) word clock output Audio serial data bus (secondary) word clock output |
| 12 | SPI_ SELECT | DI | Control mode select pin (1 = SPI, $0 = I^2C$) |
| 13 | IN1_L | AI | Multifunction Analog Input, or Single-ended configuration: Line 1 left or Differential configuration: Line right, negative |
| 14 | IN1_R | AI | Multifunction Analog Input, or Single-ended configuration: or Line 1 right or Differential configuration: Line right, positive |
| 15 | IN2_L | Al | Multifunction Analog Input, or Single-ended configuration: Line 2 left or Differential configuration: Line left, positive |
| 16 | IN2_R | AI | Multifunction Analog Input, or Single-ended configuration: Line 2 right or Differential configuration: Line left, negative |
| 17 | AV _{SS} | Ground | Analog ground supply |
| 18 | REF | AO | Reference voltage output for filtering |
| 19 | NC | | NC, do not connect |
| 20 | IN3_L | AI | Multifunction Analog Input, or Single-ended configuration: Line 3 left, or Differential configuration: Line left, positive, or Differential configuration: Line right, negative |
| 21 | IN3_R | AI | Multifunction Analog Input, or Single-ended configuration: Line 3 right, or Differential configuration: Line left, negative, or Differential configuration: Line right, positive |
| 22 | LOL | AO | Left line output |
| 23 | LOR | AO | Right line output |
| 24 | AV _{DD} | Power | Analog voltage supply 1.5V–1.95V Input when A-LDO disabled, Filtering output when A-LDO enabled |
| 25 | HPL | AO | Left high power output driver |
| 26 | LDOIN/HPVDD | Power | LDO Input supply and Headphone Power supply 1.9V- 3.6V |



Pin Functions (continued)

| PIN | NAME | TYPE ⁽¹⁾ | DESCRIPTION |
|-------------|------------------|---------------------|--|
| 27 | HPR | AO | Right high power output driver |
| 28 | DV _{SS} | Ground | Digital Ground and Chip-substrate |
| 29 | DV_DD | Power | If LDO_SELECT Pin = 0 (D-LDO disabled) |
| | | | Digital voltage supply 1.26V – 1.95V |
| | | | If LDO_SELECT Pin = 1 (D-LDO enabled) |
| | | | Digital voltage supply filtering output |
| 30 | LDO_ SELECT | DI | D-LDO enable signal (1 = D-LDO enable, 0 = D-LDO disabled) |
| 31 | RESET | DI | Reset (active low) |
| 32 | GPIO | DI | Primary function: |
| | | | General Purpose digital IO |
| | MFP5 | | Secondary function: |
| | | | CLKOUT Output |
| | | | INT1 Output |
| | | | INT2 Output |
| | | | Audio serial data bus ADC word clock output |
| | | | Audio serial data bus (secondary) bit clock output |
| | | | Audio serial data bus (secondary) word clock output |
| Thermal Pad | Thermal Pad | N/A | Connect to PCB ground plane. Not internally connected. |

Submit Documentation Feedback



8 Specifications

8.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)

| | | MIN | MAX | UNIT |
|--|--|------|------------------|------|
| | AV _{DD} to AV _{SS} | -0.3 | 2.2 | V |
| Input voltage | DV _{DD} to DV _{SS} | -0.3 | 2.2 | V |
| | IOV _{DD} to IOV _{SS} | -0.3 | 3.9 | ٧ |
| | LDOIN to AV _{SS} | -0.3 | 3.9 | ٧ |
| Digital Input voltage | Digital Input voltage | | $IOV_{DD} + 0.3$ | ٧ |
| Analog input voltage | nalog input voltage | | $AV_{DD} + 0.3$ | ٧ |
| Operating temperature ran | perating temperature range | | 85 | ô |
| Junction temperature (T _J N | Max) | | 105 | °C |

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

8.2 Handling Ratings

| | | | MIN | MAX | UNIT |
|--------------------|-------------------------|---|------|-----|------|
| T _{stg} | Storage temperature | range | -55 | 125 | °C |
| | Flootroototio | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins (1) | -2 | 2 | kV |
| V _(ESD) | Electrostatic discharge | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2) | -750 | 750 | V |

⁽¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

8.3 Recommended Operating Conditions

| | . 5 | | MIN | NOM | MAX | UNIT | |
|---------------------------------|---|--|-------|-------|-------------------------------------|-------|--|
| LDOIN | | Referenced to AV _{SS} ⁽¹⁾ | 1.9 | | 3.6 | | |
| AV_{DD} | , , | Referenced to AV _{SS} */ | 1.5 | 1.8 | 1.95 | V | |
| IOV_{DD} | Power Supply Voltage Range | Referenced to IOV _{SS} ⁽¹⁾ | 1.5 | | 3.6 | v | |
| DV _{DD} ⁽²⁾ | | Referenced to DV _{SS} ⁽¹⁾ | | 1.8 | 1.95 | | |
| | DL Input Fraguency | Clock divider uses fractional divide $(D > 0)$, $P = 1$, $DV_{DD} \ge 1.65V$ | 10 | | 20 | MHz | |
| PLL Input Frequency | | Clock divider uses integer divide (D = 0), P = 1, DV _{DD} ≥ 1.65V | 0.512 | | 20 | MHz | |
| MCLK | Master Clark Fragueses | MCLK; Master Clock Frequency; DV _{DD} ≥ 1.65V | | | 50 | MHz | |
| IVICLK | Master Clock Frequency | MCLK; Master Clock Frequency; DV _{DD} ≥ 1.26V | | | 25 | IVITZ | |
| SCL | SCL Clock Frequency | | | | 400 | kHz | |
| | Audio input max ac signal swing | CM = 0.75 V | 0 | 0.530 | 0.75 or AVDD-0.75 ⁽³⁾ | Vpeak | |
| | (IN1_L, IN1_R, IN2_L, IN2_R, IN3_L, IN3_R) | CM = 0.9 V | 0 | 0.707 | 0.9 or AVDD-0.9 ⁽³⁾ | Vpeak | |
| C _{Lout} | Digital output load capacitance | | | 10 | | pF | |
| T _{OPR} | Operating Temperature Range | | -40 | | 85 | °C | |

⁽¹⁾ All grounds on board are tied together to prevent voltage differences of more than 0.2V maximum for any combination of ground signals.

(3) Whichever is smaller.

⁽²⁾ JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

⁽²⁾ At DV_{DD} values lower than 1.65V, the PLL does not function. Refer to the Maximum PCM3070 Clock Fréquencies table in the PCM3070 Application Reference Guide (SLAU332) for details on maximum clock frequencies.



8.4 Thermal Information

| | | PCM3070 | |
|--------------------|--|-----------|------|
| | THERMAL METRIC ⁽¹⁾ | RHB (QFN) | UNIT |
| | | 32 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 31.4 | |
| $R_{\theta JCtop}$ | Junction-to-case (top) thermal resistance | 21.4 | |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 5.4 | °C/W |
| ΨЈТ | Junction-to-top characterization parameter | 0.2 | C/VV |
| ΨЈВ | Junction-to-board characterization parameter | 5.4 | |
| $R_{\theta JCbot}$ | Junction-to-case (bottom) thermal resistance | 0.9 | |

⁽¹⁾ For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

8.5 Electrical Characteristics, ADC

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------|---|--|-----|-------|-----|-----------|
| AUDIO A | DC | | | | | |
| | Input signal level (0dB) | Single-ended, CM = 0.9V | | 0.5 | | V_{RMS} |
| | Device Setup | 1kHz sine wave input , Single-ended Configuration IN1_R to Right ADC and IN1_L to Left ADC, $R_{in} = 20K, f_s = 48kHz, \\ AOSR = 128, MCLK = 256 \times f_s, \\ PLL Disabled; AGC = OFF, Channel Gain = 0dB, \\ Processing Block = PRB_R1, \\$ | | | | |
| | | Inputs ac-shorted to ground | 80 | 93 | | |
| SNR | Signal-to-noise ratio, A-weighted ⁽¹⁾⁽²⁾ | IN2_R, IN3_R routed to Right ADC and ac-shorted to ground IN2_L, IN3_L routed to Left ADC and ac-shorted to ground | | 93 | | dB |
| DR | Dynamic range A-weighted ⁽¹⁾⁽²⁾ | -60dB full-scale, 1-kHz input signal | | 92 | | dB |
| | | -3 dB full-scale, 1-kHz input signal | | -85 | -70 | |
| THD+N | Total Harmonic Distortion plus Noise | IN2_R, IN3_R routed to Right ADC IN2_L, IN3_L routed to Left ADC -3dB full-scale, 1-kHz input signal | | -85 | | dB |
| AUDIO A | DC | | | | | |
| | Input signal level (0dB) | Single-ended, CM = 0.75V, AV _{DD} = 1.5V | | 0.375 | | V_{RMS} |
| | Device Setup | 1kHz sine wave input, Single-ended Configuration IN1_R, IN2_R, IN3_R routed to Right ADC IN1_L, IN2_L, IN3_L routed to Left ADC $R_{in} = 20k\Omega, f_s = 48kHz, \\ AOSR = 128, MCLK = 256 \times f_s, \\ PLL Disabled, AGC = OFF, Channel Gain = 0dB, \\ Processing Block = PRB_R1$ | | | | |
| SNR | Signal-to-noise ratio, A-weighted (1)(2) | Inputs ac-shorted to ground | | 91 | | dB |
| DR | Dynamic range A-weighted ⁽¹⁾⁽²⁾ | -60dB full-scale, 1-kHz input signal | | 90 | | dB |
| THD+N | Total Harmonic Distortion plus Noise | -3dB full-scale, 1-kHz input signal | | -80 | | dB |

⁽¹⁾ Ratio of output level with 1kHz full-scale sine wave input, to the output level with the inputs short circuited, measured A-weighted over a 20Hz to 20kHz bandwidth using an audio analyzer.

⁽²⁾ All performance measured with 20kHz low-pass filter and, where noted, A-weighted filter. Failure to use such a filter may result in higher THD+N and lower SNR and dynamic range readings than shown in the Electrical Characteristics. The low-pass filter removes out-of-band noise, which, although not audible, may affect dynamic specification values.



Electrical Characteristics, ADC (continued)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-------|---|---|-----|-------|-----|---------------|
| AUDIO | ADC | | | | | |
| | Input signal level (0dB) | Differential Input, CM = 0.9V | | 10 | | mV |
| | Device Setup | 1kHz sine wave input, Differential configuration IN1_L and IN1_R routed to Right ADC IN2_L and IN2_R routed to Left ADC R _{in} = 10K, f _s = 48kHz, AOSR = 128 MCLK = 256* f _s PLL Disabled AGC = OFF, Channel Gain = 40dB Processing Block = PRB_R1, | | | | |
| ICN | Idle-Channel Noise, A-weighted (1)(2) | Inputs ac-shorted to ground, input referred noise | | 2 | | μV_{RMS} |
| AUDIO | ADC | | 1 | | , | |
| | Gain Error | $ \begin{array}{l} 1 \text{kHz sine wave input , Single-ended configuration} \\ R_{\text{in}} = 20 \text{k}\Omega f_{\text{s}} = 48 \text{kHz, AOSR} = 128, \\ \text{MCLK} = 256 \times f_{\text{s}}, \text{PLL Disabled} \\ \text{AGC} = \text{OFF, Channel Gain} = 0 \text{dB} \\ \text{Processing Block} = \text{PRB_R1}, \\ \end{array} $ | | -0.05 | | dB |
| | Input Channel Separation | 1kHz sine wave input at -3dBFS Single-ended configuration IN1_L routed to Left ADC IN1_R routed to Right ADC, R _{in} = 20kΩ AGC = OFF, AOSR = 128, Channel Gain = 0dB, CM = 0.9V | | 108 | | dB |
| | Input Pin Crosstalk | 1kHz sine wave input at –3dBFS on IN2_L, IN2_L internally not routed. IN1_L routed to Left ADC ac-coupled to ground 1kHz sine wave input at –3dBFS on IN2_R, IN2_R internally not routed. IN1_R routed to Right ADC ac-coupled to ground | | 115 | | dB |
| | | Single-ended configuration $R_{in}=20k\Omega,$ AOSR = 128 Channel, Gain = 0dB, CM = 0.9V | | | | |
| | PSRR | 217Hz, 100mVpp signal on AV_{DD} , Single-ended configuration, $R_{in}=20k\Omega$, Channel Gain = 0dB; $CM=0.9V$ | | 55 | | dB |
| | | Single-Ended, $R_{in} = 10k\Omega$, PGA gain set to 0dB | | 0 | | dB |
| | | Single-Ended, $R_{in} = 10k\Omega$, PGA gain set to 47.5dB | | 47.5 | | dB |
| | ADC programmable gain amplifier | Single-Ended, $R_{in} = 20k\Omega$, PGA gain set to 0dB | | -6 | | dB |
| | gain | Single-Ended, $R_{in} = 20k\Omega$, PGA gain set to 47.5dB | | 41.5 | | dB |
| | | Single-Ended, $R_{in} = 40k\Omega$, PGA gain set to 0dB | | -12 | | dB |
| | | Single-Ended, $R_{in} = 40k\Omega$, PGA gain set to 47.5dB | | 35.5 | | dB |
| | ADC programmable gain amplifier step size | 1-kHz tone | | 0.5 | | dB |



8.6 Electrical Characteristics, Bypass Outputs

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|-------------------------------------|---|-----|------|-----|---------------|
| ANAL | OG BYPASS TO HEADPHONE AMPLIFIER | , DIRECT MODE | | | | |
| | Device Setup | Load = 16Ω (single-ended), 50pF; Input and Output CM = 0.9V; Headphone Output on LDOIN Supply; IN1_L routed to HPL and IN1_R routed to HPR; Channel Gain = 0dB | | | | |
| | Gain Error | | | -0.8 | | dB |
| Noise, A-weighted ⁽¹⁾ Idle Chanr ground | | Idle Channel, IN1_L and IN1_R ac-shorted to ground | | 3 | | μV_{RMS} |
| THD | Total Harmonic Distortion | 446mVrms, 1kHz input signal | | -89 | | dB |
| ANAL | OG BYPASS TO LINE-OUT AMPLIFIER, PO | GA MODE | | | * | |
| Device Setup | | Load = $10k\Omega$ (single-ended), $56pF$; Input and Output CM = $0.9V$; LINE Output on LDOIN Supply; IN1_L routed to ADCPGA_L and IN1_R routed to ADCPGA_R; $R_{in} = 20k\Omega$ ADCPGA_L routed to LOL and ADCPGA_R routed to LOR; Channel Gain = $0dB$ | | | | |
| | Gain Error | | | 0.6 | | dB |
| | | Idle Channel, IN1_L and IN1_R ac-shorted to ground | | 7 | | μV_{RMS} |
| | Noise, A-weighted ⁽¹⁾ | Channel Gain = 40dB, Input Signal (0dB) = 5mV _{rms} Inputs ac-shorted to ground, Input Referred | | 3.4 | | μV_{RMS} |

⁽¹⁾ All performance measured with 20kHz low-pass filter and, where noted, A-weighted filter. Testing without such a filter may result in higher THD+N and lower SNR and dynamic range readings than shown in the Electrical Characteristics. The low-pass filter removes out-of-band noise, which, although not audible, may affect dynamic specification values.



8.7 Electrical Characteristics, Audio DAC Outputs

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------|---|--|-----|-------|-----|-----------|
| AUDIO I | DAC – STEREO SINGLE-ENDED LINE O | UTPUT | | | | |
| | Device Setup | Load = $10k\Omega$ (single-ended), $56pF$ Line Output on AV_{DD} Supply Input and Output CM = $0.9V$ DOSR = 128 , MCLK = 256 x f_s , Channel Gain = $0dB$, word length = 16 bits, Processing Block = PRB_P1 , | | | | |
| | Full scale output voltage (0dB) | | | 0.5 | | V_{RMS} |
| SNR | Signal-to-noise ratio A-weighted ⁽¹⁾⁽²⁾ | All zeros fed to DAC input | 87 | 100 | | dB |
| DR | Dynamic range, A-weighted (1)(2) | -60dB 1kHz input full-scale signal, Word length = 20 bits | | 100 | | dB |
| THD+N | Total Harmonic Distortion plus Noise | -3dB full-scale, 1kHz input signal | | -83 | -70 | dB |
| | DAC Gain Error | 0 dB, 1kHz input full scale signal | | 0.3 | | dB |
| | DAC Mute Attenuation | Mute | | 119 | | dB |
| | DAC channel separation | -1 dB, 1kHz signal, between left and right HP out | | 113 | | dB |
| | DAC PSRR | 100mVpp, 1kHz signal applied to AV _{DD} | | 73 | | dB |
| | DACFSKK | 100mVpp, 217Hz signal applied to AV _{DD} | | 77 | | dB |
| AUDIO [| DAC – STEREO SINGLE-ENDED LINE O | UTPUT | | | · | |
| | Device Setup | Load = $10k\Omega$ (single-ended), 56pF Line Output on AV_{DD} Supply Input and Output CM = $0.75V$; AV_{DD} = $1.5V$ DOSR = 128 MCLK = $256 * fs$ Channel Gain = $-2dB$ word length = 20 bits Processing Block = PRB_P1 | | | | |
| | Full scale output voltage (0dB) | | | 0.375 | | V_{RMS} |
| SNR | Signal-to-noise ratio, A-weighted ⁽¹⁾⁽²⁾ | All zeros fed to DAC input | | 99 | | dB |
| DR | Dynamic range, A-weighted (1)(2) | -60dB 1 kHz input full-scale signal | | 97 | | dB |
| THD+N | Total Harmonic Distortion plus Noise | -1 dB full-scale, 1-kHz input signal | | -85 | | dB |
| AUDIO I | DAC – STEREO SINGLE-ENDED HEADF | PHONE OUTPUT | | | | |
| | Device Setup | Load = 16Ω (single-ended), $50pF$ Headphone Output on AV_{DD} Supply, Input and Output CM = $0.9V$, DOSR = 128 , MCLK = $256 * f_s$, Channel Gain = $0dB$ word length = 16 bits; Processing Block = PRB_P1 | | | | |
| | Full scale output voltage (0dB) | | | 0.5 | | V_{RMS} |
| SNR | Signal-to-noise ratio, A-weighted ⁽¹⁾⁽²⁾ | All zeros fed to DAC input | 87 | 100 | | dB |
| DR | Dynamic range, A-weighted (1)(2) | -60dB 1kHz input full-scale signal, Word Length = 20 bits | | 99 | | dB |
| THD+N | Total Harmonic Distortion plus Noise | -3dB full-scale, 1kHz input signal | | -83 | -70 | dB |
| | DAC Gain Error | 0dB, 1kHz input full scale signal | | -0.3 | | dB |
| | DAC Mute Attenuation | Mute | | 122 | | dB |
| | DAC channel separation | -1dB, 1kHz signal, between left and right HP out | | 110 | | dB |
| | DAC PSRR | 100mVpp, 1kHz signal applied to AV _{DD} | | 73 | | dB |
| | D. CO I OICE | 100mVpp, 217Hz signal applied to AV _{DD} | | 78 | | dB |

⁽¹⁾ Ratio of output level with 1kHz full-scale sine wave input, to the output level with the inputs short circuited, measured A-weighted over a 20Hz to 20kHz bandwidth using an audio analyzer.

⁽²⁾ All performance measured with 20kHz low-pass filter and, where noted, A-weighted filter. Testing without such a filter may result in higher THD+N and lower SNR and dynamic range readings than shown in the Electrical Characteristics. The low-pass filter removes out-of-band noise, which, although not audible, may affect dynamic specification values



Electrical Characteristics, Audio DAC Outputs (continued)

| | PARAMETER | TEST CONDITIONS | MIN TYP | MAX | UNIT |
|-------|--|---|---------|-----|------------|
| | Power Delivered | $R_L = 16\Omega$, Output Stage on $AV_{DD} = 1.8V$ THDN < 1%, Input CM = 0.9V, Output CM = 0.9V | 15 | | mW |
| | Power Delivered | $R_L = 16\Omega$ Output Stage on LDOIN = 3.3V, THDN < 1% Input CM = 0.9V, Output CM = 1.65V | 64 | | IIIVV |
| AUDIO | DAC – STEREO SINGLE-ENDED HEADP | PHONE OUTPUT | | | |
| | Device Setup | Load = 16Ω (single-ended), $50pF$, Headphone Output on AV_{DD} Supply, Input and Output CM = $0.75V$; $AV_{DD} = 1.5V$, DOSR = 128 , MCLK = $256 * f_s$, Channel Gain = $-2dB$, word length = 20 -bits; Processing Block = PRB_P1 , | | | |
| | Full scale output voltage (0dB) | | 0.375 | | V_{RMS} |
| SNR | Signal-to-noise ratio, A-weighted (1)(2) | All zeros fed to DAC input | 99 | | dB |
| DR | Dynamic range, A-weighted (1)(2) | -60dB 1kHz input full-scale signal | 98 | | dB |
| THD+N | Total Harmonic Distortion plus Noise | -1dB full-scale, 1kHz input signal | -83 | | dB |
| AUDIO | DAC – MONO DIFFERENTIAL HEADPHO | ONE OUTPUT | | | |
| | Device Setup | Load = 32Ω (differential), 50pF, Headphone Output on LDOIN Supply Input CM = 0.75V, Output CM = 1.5V, AV _{DD} = 1.8V, LDOIN = 3.0V, DOSR = 128 MCLK = 256 * f _s , Channel (headphone driver) Gain = 5dB for full scale output signal, word length = 16 bits, Processing Block = PRB_P1, | | | |
| | Full scale output voltage (0dB) | | 1778 | | mV_{RMS} |
| SNR | Signal-to-noise ratio, A-weighted (1)(2) | All zeros fed to DAC input | 98 | | dB |
| DR | Dynamic range, A-weighted (1)(2) | -60dB 1kHz input full-scale signal | 96 | | dB |
| THD | Total Harmonic Distortion | -3dB full-scale, 1kHz input signal | -82 | | dB |
| | Power Delivered | $R_L = 32\Omega$, Output Stage on LDOIN = 3.3V, THDN < 1%, Input CM = 0.9V, Output CM = 1.65V | 136 | | mW |
| | rowei Deliverea | $R_L = 32\Omega$ Output Stage on LDOIN = 3.0V, THDN < 1% Input CM = 0.9V, Output CM = 1.5V | 114 | | mW |
| | | | | | |



8.8 Electrical Characteristics, LDO

over operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------------------|---------------------------------|-----|------|-----|------|
| LOW DROPOUT REGULATOR (AVdd) | | | | | |
| | LDOMode = 1, LDOIN > 1.95V | | 1.67 | | |
| Output Voltage | LDOMode = 0, LDOIN > 2.0V | | 1.72 | | V |
| | LDOMode = 2, LDOIN > 2.05V | | 1.77 | | |
| Output Voltage Accuracy | | | ±2% | | |
| Load Regulation | Load current range 0 to 50mA | | 15 | | mV |
| Line Regulation | Input Supply Range 1.9V to 3.6V | | 5 | | mV |
| Decoupling Capacitor | | 1 | | | μF |
| Bias Current | | | 60 | | μΑ |

8.9 Electrical Characteristics, Misc.

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------------------------|--|-----|------|-----|-----------------|
| REFERENCE | | | | | |
| Deference Voltage Cettings | CMMode = 0 (0.9V) | | 0.9 | | V |
| Reference Voltage Settings | CMMode = 1 (0.75V) | | 0.75 | | V |
| Reference Noise | CM = 0.9V, A-weighted, 20Hz to 20kHz bandwidth, $C_{\rm ref} = 10 \mu F$ | | 1 | | μV_{RfcMS} |
| Decoupling Capacitor | | 1 | 10 | | μF |
| miniDSP ⁽¹⁾ | | | | | |
| Maximum miniDSP clock frequency - ADC | DV _{DD} = 1.65V | | 55.3 | | MHz |
| Maximum miniDSP clock frequency - DAC | DV _{DD} = 1.65V | | 55.3 | | MHz |
| Shutdown Current | | | | | |
| Device Setup | Coarse AVdd supply turned off, LDO_select held at ground, No external digital input is toggled | | | | |
| I(DV _{DD}) | | | 0.9 | | μA |
| I(IOVDD) | | | 13 | | nA |

⁽¹⁾ miniDSP clock speed is specified by design and not tested in production.

8.10 Electrical Characteristics, Logic Levels (1)

At 25°C, AV_{DD} , DV_{DD} , $IOV_{DD} = 1.8V$

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT | | | | |
|-----------------------------|--|-------------------------|------|----------------------------|------|--|--|--|--|
| LOGIC FAMILY | | | CMOS | | | | | | |
| | I _{IH} = 5 μA, IOV _{DD} > 1.6V | 0.7 × IOV _{DD} | | | V | | | | |
| V _{IH} Logic Level | $I_{IH} = 5\mu A, 1.2V \le IOV_{DD} < 1.6V$ | 0.9 × IOV _{DD} | | | V | | | | |
| | $I_{IH} = 5\mu A$, $IOV_{DD} < 1.2V$ | IOV _{DD} | | | V | | | | |
| | I _{IL} = 5 μA, IOV _{DD} > 1.6V | -0.3 | 0.3 | × IOV _{DD} | V | | | | |
| V_{IL} | $I_{IL} = 5\mu A, 1.2V \le IOV_{DD} < 1.6V$ | | 0.1 | \times IOV _{DD} | V | | | | |
| | $I_{IL} = 5\mu A$, $IOV_{DD} < 1.2V$ | | | 0 | V | | | | |
| V _{OH} | I _{OH} = 2 TTL loads | 0.8 × IOV _{DD} | | | V | | | | |
| V _{OL} | I _{OL} = 2 TTL loads | | 0.1 | × IOV _{DD} | V | | | | |
| Capacitive L | oad | | 10 | | pF | | | | |

(1) Applies to all DI, DO, and DIO pins shown in Pin Configuration and Functions.

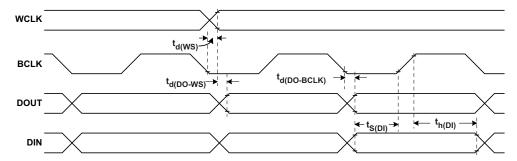
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8.11 I²S LJF and RJF Timing in Master Mode (see Figure 1)

| | | IOVDD = 1.8V | IOVDD = 3.3V | UNIT |
|-------------------------|--|--------------|--------------|------|
| | | MIN MAX | MIN MAX | UNII |
| t _{d(WS)} | WCLK delay | 30 | 20 | ns |
| t _{d(DO-WS)} | WCLK to DOUT delay (For LJF Mode only) | 20 | 20 | ns |
| t _{d(DO-BCLK)} | BCLK to DOUT delay | 22 | 20 | ns |
| t _{s(DI)} | DIN setup | 8 | 8 | ns |
| t _{h(DI)} | DIN hold | 8 | 8 | ns |
| t _r | Rise time | 24 | 12 | ns |
| t _f | Fall time | 24 | 12 | ns |



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8.12 I²S LJF and RJF Timing in Slave Mode (see Figure 2)

| | , , | IOVDD = 1 | IOVDD = 1.8V | | 3.3V | UNIT |
|-------------------------|--|-----------|--------------|----|---------|------|
| | | MIN | MIN MAX | | MIN MAX | |
| t _{H(BCLK)} | BCLK high period | 35 | | 35 | | ns |
| t _{L(BCLK)} | BCLK low period | 35 | | 35 | | ns |
| t _{s(WS)} | WCLK setup | 8 | | 8 | | ns |
| t _{h(WS)} | WCLK hold | 8 | | 8 | | ns |
| t _{d(DO-WS)} | WCLK to DOUT delay (For LJF mode only) | | 20 | | 20 | ns |
| $t_{d(DO\text{-BCLK})}$ | BCLK to DOUT delay | | 22 | | 22 | ns |
| $t_{s(DI)}$ | DIN setup | 8 | | 8 | | ns |
| $t_{h(DI)}$ | DIN hold | 8 | | 8 | | ns |
| t _r | Rise time | | 4 | | 4 | ns |
| t _f | Fall time | | 4 | | 4 | ns |

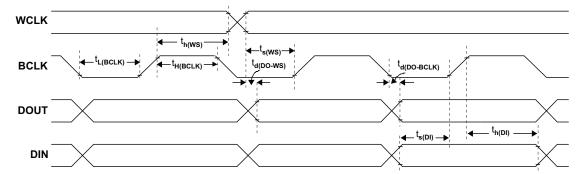
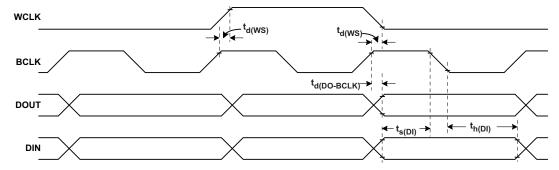


Figure 2. I²S LJF and RJF Timing in Slave Mode



8.13 DSP Timing in Master Mode (see Figure 3)

| | | IOVDD = 1.8V | | IOVDD = 3.3V | | UNIT |
|-------------------------|--------------------|--------------|-----|--------------|-----|------|
| | | MIN | MAX | MIN | MAX | |
| t _{d(WS)} | WCLK delay | | 30 | | 20 | ns |
| t _{d(DO-BCLK)} | BCLK to DOUT delay | | 22 | | 20 | ns |
| t _{s(DI)} | DIN setup | 8 | | 8 | | ns |
| t _{h(DI)} | DIN hold | 8 | | 8 | | ns |
| t _r | Rise time | | 24 | | 12 | ns |
| t _f | Fall time | | 24 | | 12 | ns |



All specifications at 25°C, DVdd = 1.8V

Figure 3. DSP Timing in Master Mode



8.14 DSP Timing in Slave Mode (see Figure 4)

| | | IOVDD = | IOVDD = 1.8V | | IOVDD = 3.3V | |
|-------------------------|--------------------|---------|--------------|-----|--------------|----|
| | | MIN | MAX | MIN | MAX | |
| t _{H(BCLK)} | BCLK high period | 35 | | 35 | | ns |
| t _{L(BCLK)} | BCLK low period | 35 | | 35 | | ns |
| t _{s(WS)} | WCLK setup | 8 | | 8 | | ns |
| t _{h(WS)} | WCLK hold | 8 | | 8 | | ns |
| t _{d(DO-BCLK)} | BCLK to DOUT delay | | 22 | | 22 | ns |
| t _{s(DI)} | DIN setup | 8 | | 8 | | ns |
| t _{h(DI)} | DIN hold | 8 | | 8 | | ns |
| t _r | Rise time | | 4 | | 4 | ns |
| t _f | Fall time | | 4 | | 4 | ns |

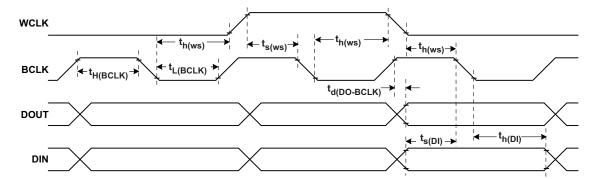


Figure 4. DSP Timing in Slave Mode



8.15 I²C Interface Timing

| | | Stand | dard-Mod | de | Fast | | UNIT | |
|---------------------|--|-------|----------|------|----------------------|-----|------|-----|
| | | MIN | TYP | MAX | MIN | TYP | MAX | |
| f _{SCL} | SCL clock frequency | 0 | | 100 | 0 | | 400 | kHz |
| t _{HD;STA} | Hold time (repeated) START condition. After this period, the first clock pulse is generated. | 4.0 | | | 0.8 | | | μs |
| t _{LOW} | LOW period of the SCL clock | 4.7 | | | 1.3 | | | μs |
| t _{HIGH} | HIGH period of the SCL clock | 4.0 | | | 0.6 | | | μs |
| t _{SU;STA} | Setup time for a repeated START condition | 4.7 | | | 0.8 | | | μs |
| t _{HD;DAT} | Data hold time: For I2C bus devices | 0 | | 3.45 | 0 | | 0.9 | μs |
| t _{SU;DAT} | Data set-up time | 250 | | | 100 | | | ns |
| t _r | SDA and SCL Rise Time | | | 1000 | 20+0.1C _b | | 300 | ns |
| t _f | SDA and SCL Fall Time | | | 300 | 20+0.1C _b | | 300 | ns |
| t _{SU;STO} | Set-up time for STOP condition | 4.0 | | | 0.8 | | | μs |
| t _{BUF} | Bus free time between a STOP and START condition | 4.7 | | | 1.3 | | | μs |
| C _b | Capacitive load for each bus line | | | 400 | | | 400 | pF |

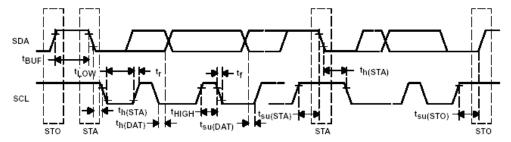


Figure 5. I²C Interface Timing



8.16 SPI Interface Timing (See Figure 6)

| | | IOVDD = 1.8V | | | IOVDD = 3.3V | | | UNIT |
|-----------------------|----------------------------|--------------|-------|----|--------------|-----|-----|------|
| | | MIN | TYP M | AX | MIN | TYP | MAX | |
| t _{sck} | SCLK Period ⁽¹⁾ | 100 | | | 50 | | | ns |
| t _{sckh} | SCLK Pulse width High | 50 | | | 25 | | | ns |
| t _{sckl} | SCLK Pulse width Low | 50 | | | 25 | | | ns |
| t _{lead} | Enable Lead Time | 30 | | | 20 | | | ns |
| t _{trail} | Enable Trail Time | 30 | | | 20 | | | ns |
| t _{d;seqxfr} | Sequential Transfer Delay | 40 | | | 20 | | | ns |
| ta | Slave DOUT access time | | | 40 | | | 20 | ns |
| t _{dis} | Slave DOUT disable time | | | 40 | | | 20 | ns |
| t _{su} | DIN data setup time | 15 | | | 10 | | | ns |
| t _{h(DIN)} | DIN data hold time | 15 | | | 10 | | | ns |
| t _{v(DOUT)} | DOUT data valid time | | | 25 | | | 18 | ns |
| t _r | SCLK Rise Time | | | 4 | | | 4 | ns |
| t _f | SCLK Fall Time | | | 4 | | | 4 | ns |

(1) These parameters are based on characterization and are not tested in production.

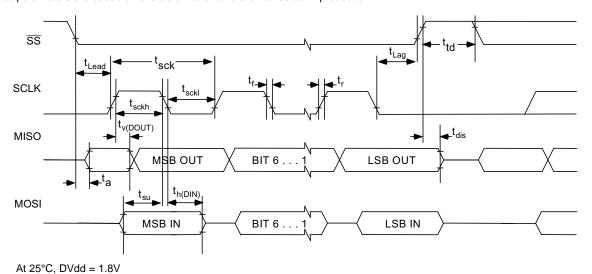
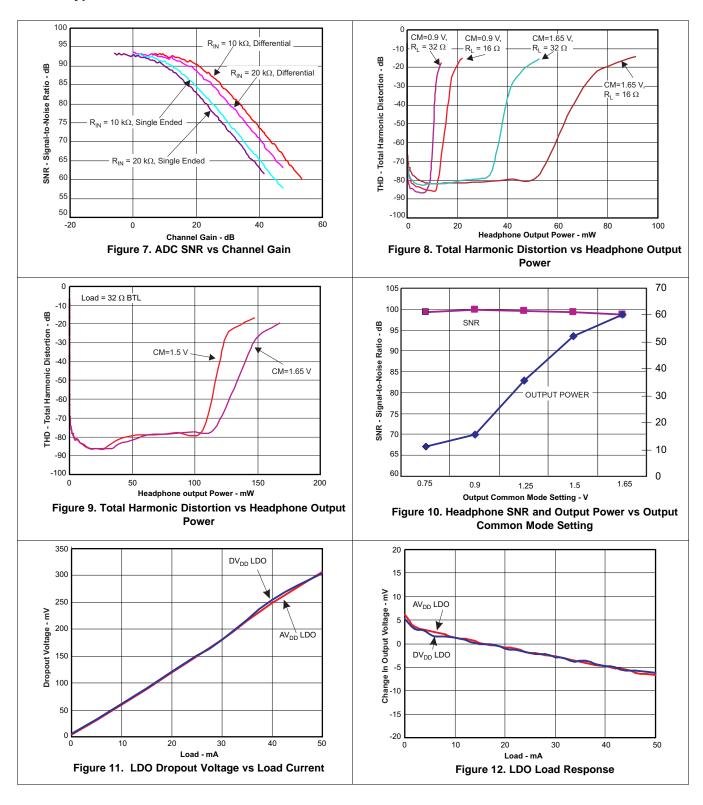


Figure 6. SPI Interface Timing Diagram



8.17 Typical Characteristics

8.17.1 Typical Performance

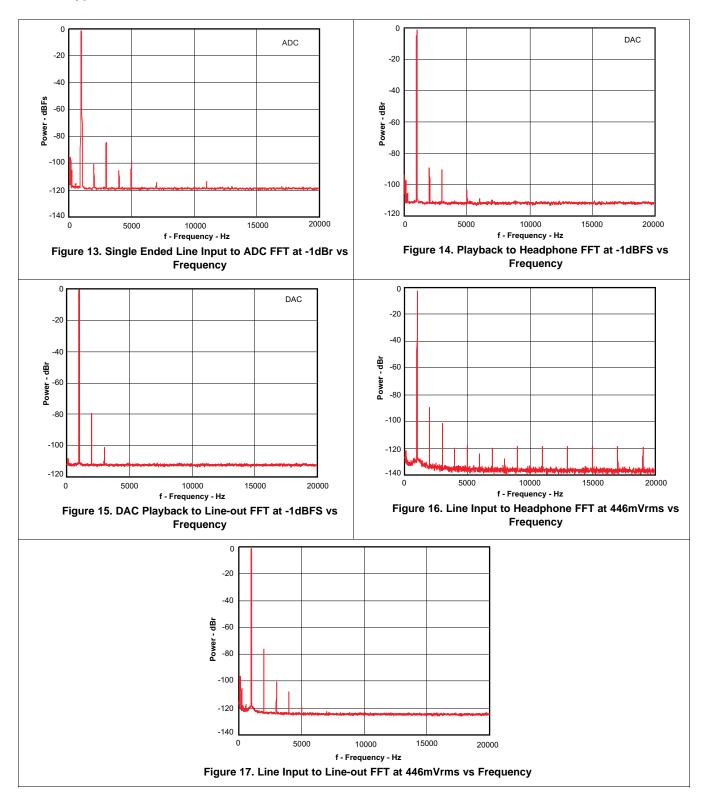


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8.17.2 Typical Characteristics, FFT





9 Parameter Measurement Information

All parameters are measured according to the conditions described in the *Specifications* section.

10 Detailed Description

10.1 Overview

The PCM3070 features two fully-programmable miniDSP cores that support application-specific algorithms in the record and/or the playback path of the device. The miniDSP cores are fully software controlled. Target algorithms, like speaker EQ, Crossovers, Dynamic Range Controls, Intelligent volume controls and other post-processing algorithms are loaded into the device after power-up.

Extensive register-based control of input/output channel configuration, gains, effects, pin-multiplexing and clocks is included, allowing the device to be precisely targeted to its application.

The record path of the PCM3070 covers operations from 8kHz mono to 192kHz stereo recording, and contains programmable input channel configurations covering single-ended and differential setups, as well as floating or mixed input signals.

The playback path offers signal-processing blocks for filtering and effects, and supports flexible mixing of DAC and analog input signals as well as programmable volume controls. The playback path contains two high-power output drivers as well as two fully-differential outputs. The high-power outputs can be configured in multiple ways, including stereo and mono BTL.

The voltage supply range for the PCM3070 for analog is 1.5V–1.95V, and for digital it is 1.26V–1.95V. To ease system-level design, LDOs are integrated to generate the appropriate analog or digital supply from input voltages ranging from 1.8V to 3.6V. Digital I/O voltages are supported in the range of 1.5V–3.6V.

The required internal clock of the PCM3070 can be derived from multiple sources, including the MCLK pin, the BCLK pin, the GPIO pin or the output of the internal PLL, where the input to the PLL again can be derived from the MCLK pin, the BCLK or GPIO pins. The PLL is highly programmable and can accept available input clocks in the range of 512kHz to 50MHz.



10.2 Functional Block Diagram

Figure 18 shows the basic functional blocks of the device.

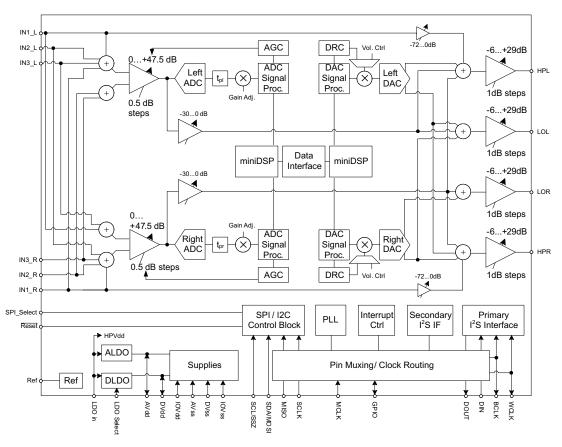


Figure 18. Block Diagram

10.3 Feature Description

10.3.1 Device Connections

10.3.1.1 Digital Pins

Only a small number of digital pins are dedicated to a single function; whenever possible, the digital pins have a default function, and also can be reprogrammed to cover alternative functions for various applications.

The fixed-function pins are Reset and the SPI_Select pin, which are HW control pins. Depending on the state of SPI_Select, the two control-bus pins SCL/SS and SDA/MOSI are configured for either I²C or SPI protocol.

Other digital IO pins can be configured for various functions via register control. An overview of available functionality is given in *Multifunction Pins*.



Feature Description (continued)

10.3.1.1.1 Multifunction Pins

Table 1 shows the possible allocation of pins for specific functions. The PLL input, for example, can be programmed to be any of 4 pins (MCLK, BCLK, DIN, GPIO).

Table 1. Multifunction Pin Assignments

| | | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 |
|---|---------------------------------------|------------------------------------|------------------|------|-------------|--------------|---------------|---------------|------------------|
| | Pin Function | MCLK | BCLK | WCLK | DIN MFP1 | DOUT MFP2 | MFP3/ SCLK | MFP4/ MISO | GPIO MFP5 |
| Α | PLL Input | S ⁽¹⁾ | S ⁽²⁾ | | E | | | | S ⁽³⁾ |
| В | Codec Clock Input | S ⁽¹⁾ ,D ⁽⁴⁾ | S ⁽²⁾ | | | | | | S ⁽³⁾ |
| С | I ² S BCLK input | | S,D | | | | | | |
| D | I ² S BCLK output | | E ⁽⁵⁾ | | | | | | |
| E | I ² S WCLK input | | | E, D | | | | | |
| F | I ² S WCLK output | | | Е | | | | | |
| G | I ² S ADC word clock input | | | | | | Е | | Е |
| Н | I ² S ADC WCLK out | | | | | | | Е | Е |
| I | I ² S DIN | | | | E, D | | | | |
| J | I ² S DOUT | | | | | E, D | | | |
| K | General Purpose Output I | | | | | Е | | | |
| K | General Purpose Output II | | | | | | | Е | |
| K | General Purpose Output III | | | | | | | | Е |
| L | General Purpose Input I | | | | Е | | | | |
| L | General Purpose Input II | | | | | | Е | | |
| L | General Purpose Input III | | | | | | | | Е |
| М | INT1 output | | | | | Е | | Е | Е |
| N | INT2 output | | | | | E | | E | E |
| Q | Secondary I ² S BCLK input | | | | | | E | | Е |
| R | Secondary I ² S WCLK in | | | | | | E | | E |
| S | Secondary I ² S DIN | | | | | | Е | | Е |
| Т | Secondary I ² S DOUT | | | | | | | Е | |
| U | Secondary I ² S BCLK OUT | | | | | Е | | Е | Е |
| ٧ | Secondary I ² S WCLK OUT | | | | | Е | | Е | Е |
| W | Reserved | | | | | | | | |
| X | Aux Clock Output | | | | | Е | | Е | Е |

⁽¹⁾ S⁽¹⁾: The MCLK pin can drive the PLL and Codec Clock inputs **simultaneously**.

10.3.1.2 Analog Pins

Analog functions can also be configured to a large degree. Analog blocks are powered down by default. The blocks can be powered up with fine granularity according to the application needs.

⁽²⁾ S⁽²⁾: The BCLK pin can drive the PLL and Codec Clock and audio interface bit clock inputs **simultaneously**.

⁽³⁾ S⁽³⁾: The GPIO/MFP5 pin can drive the PLL and Codec Clock inputs simultaneously.

⁽⁴⁾ D: Default Function

⁽⁵⁾ E: The pin is **exclusively** used for this function, no other function can be implemented with the same pin. (If GPIO/MFP5 has been allocated for General Purpose Output, it cannot be used as the INT1 output at the same time.)



10.3.2 Analog Audio I/O

The analog IO path of the PCM3070 features a large set of options for signal conditioning as well as signal routing:

- 6 analog inputs which can be mixed and-or multiplexed in single-ended and-or differential configuration
- 2 programmable gain amplifiers (PGA) with a range of 0 to +47.5dB
- · 2 mixer amplifiers for analog bypass
- · 2 low power analog bypass channels
- Mute function
- Automatic gain control (AGC)
- Channel-to-channel phase adjustment
- Fast charge of ac-coupling capacitors
- Anti thump

10.3.2.1 Analog Bypass

The PCM3070 offers two analog-bypass modes. In either of the modes, an analog input signal can be routed from an analog input pin to an amplifier driving an analog output pin. Neither the ADC nor the DAC resources are required for such operation.

In analog low-power bypass mode, line-level signals can be routed directly from the analog inputs INL to the left headphone amplifier (HPL) and INR to HPR.

10.3.2.2 ADC Bypass Using Mixer Amplifiers

In addition to the analog bypass mode, another bypass mode uses the programmable gain amplifiers of the input stage in conjunction with a mixer amplifier. With this mode, low-level signals can be amplified and routed to the line or headphone outputs, fully bypassing the ADC and DAC.

To enable this mode, the mixer amplifiers are powered on via software command.

10.3.2.3 Headphone Output

The stereo headphone drivers on pins HPL and HPR can drive loads with impedances down to 16Ω in single-ended AC-coupled headphone configurations, or loads down to 32Ω in differential mode, where a speaker is connected between HPL and HPR. In single-ended drive configuration these drivers can drive up to 15 mW power into each headphone channel while operating from 1.8 V analog supplies. While running from the AVdd supply, the output common-mode of the headphone driver is set by the common-mode setting of analog inputs in Page 1 / Register 10, Bit D6, to allow maximum utilization of the analog supply range while simultaneously providing a higher output-voltage swing. In cases when higher output-voltage swing is required, the headphone amplifiers can run directly from the higher supply voltage on LDOIN input (up to 3.6 V). To use the higher supply voltage for higher output signal swing, the output common-mode can be adjusted to either 1.25 V, 1.5 V or 1.65 V by configuring Page 1 / Register 10, Bits D5-D4. When the common-mode voltage is configured at 1.65 V and LDOIN supply is 3.3 V, the headphones can each deliver up to 40 mW power into a 16Ω load.

The headphone drivers are capable of driving a mixed combination of DAC signal and bypass from analog input INL and INR by configuring Page 1 / Register 12 and Page 1 / Register 13 respectively. The analog input signals can be attenuated up to 72dB before routing by configuring Page 1 / Register 22 and 23. The level of the DAC signal can be controlled using the digital volume control of the DAC in Page 0, Reg 65 and 66. To control the output-voltage swing of headphone drivers, the digital volume control provides a range of –6.0dB to +29.0dB(6) in steps of 1dB. These can be configured by programming Page 1 / Register 16 and 17. These level controls are not meant to be used as dynamic volume control, but more to set output levels during initial device configuration.

10.3.2.4 Line Outputs

The stereo line level drivers on LOL and LOR pins can drive a wide range of line level resistive impedances in the range of 600Ω to $10k\Omega$. The output common modes of line level drivers can be configured to equal either the analog input common-mode setting, or 1.65V. With output common-mode setting of 1.65V and DRVdd_HP supply at 3.3V the line-level drivers can drive up to 1Vrms output signal. The line-level drivers can drive out a mixed combination of DAC signal and attenuated ADC PGA signal. Signal mixing is register-programmable.



10.3.3 ADC

The PCM3070 includes a stereo audio ADC, which uses a delta-sigma modulator with a programmable oversampling ratio, followed by a digital decimation filter. The stereo recording path can be powered up one channel at a time, to support the case where only mono record capability is required.

The ADC path of the PCM3070 features a large set of options for signal conditioning as well as signal routing:

- Two ADCs
- · Six analog inputs which can be mixed and-or multiplexed in single-ended and-or differential configuration
- Two programmable gain amplifiers (PGA) with a range of 0 to +47.5dB
- · Two mixer amplifiers for analog bypass
- Two analog bypass channels
- Fine gain adjustment of digital channels with 0.1dB step size
- Digital volume control with a range of -12 to +20dB
- Mute function
- Automatic gain control (AGC)

In addition to the standard set of ADC features the PCM3070 also offers the following special functions:

- Channel-to-channel phase adjustment
- Fast charge of ac-coupling capacitors
- Anti thump
- Adaptive filter mode

10.3.3.1 ADC Processing

The PCM3070 offers a range of processing blocks which implement various signal processing capabilities along with decimation filtering. These processing blocks give users the choice of how much and what type of signal processing they may use and which decimation filter is applied.

10.3.3.1.1 ADC Processing Blocks

The PCM3070 offers a range of processing blocks which implement various signal processing capabilities along with decimation filtering. These processing blocks give users the choice of how much and what type of signal processing they may use and which decimation filter is applied.

Table 2 gives an overview of the available processing blocks and their properties.

The signal processing blocks available are:

- First-order IIR
- Scalable number of biquad filters
- Variable-tap FIR filter
- AGC

The processing blocks are tuned for common cases and can achieve high anti-alias filtering or low group delay in combination with various signal processing effects such as audio effects and frequency shaping. The available first order IIR, BiQuad and FIR filters have fully user-programmable coefficients. The Resource Class Column (RC) gives an approximate indication of power consumption.



Table 2. ADC Processing Blocks

| Processing Blocks | Channel | Decimation Filter | 1st Order IIR Available | Number BiQuads | FIR | Required AOSR Value | Resource Class |
|-----------------------|---------|----------------------|----------------------------|-------------------|--------|---------------------|-------------------|
| PRB_R1 ⁽¹⁾ | Stereo | Α | Yes | 0 | No | 128,64 | 6 |
| PRB_R2 | Stereo | Α | Yes | 5 | No | 128,64 | 8 |
| PRB_R3 | Stereo | Α | Yes | 0 | 25-Tap | 128,64 | 8 |
| PRB_R4 | Right | Α | Yes | 0 | No | 128,64 | 3 |
| PRB_R5 | Right | Α | Yes | 5 | No | 128,64 | 4 |
| PRB_R6 | Right | Α | Yes | 0 | 25-Tap | 128,64 | 4 |
| PRB_R7 | Stereo | В | Yes | 0 | No | 64 | 3 |
| PRB_R8 | Stereo | В | Yes | 3 | No | 64 | 4 |
| PRB_R9 | Stereo | В | Yes | 0 | 20-Tap | 64 | 4 |
| PRB_R10 | Right | В | Yes | 0 | No | 64 | 2 |
| PRB_R11 | Right | В | Yes | 3 | No | 64 | 2 |
| PRB_R12 | Right | В | Yes | 0 | 20-Tap | 64 | 2 |
| PRB_R13 | Stereo | С | Yes | 0 | No | 32 | 3 |
| PRB_R14 | Stereo | С | Yes | 5 | No | 32 | 4 |
| PRB_R15 | Stereo | С | Yes | 0 | 25-Tap | 32 | 4 |
| PRB_R16 | Right | С | Yes | 0 | No | 32 | 2 |
| PRB_R17 | Right | С | Yes | 5 | No | 32 | 2 |
| PRB_R18 | Right | С | Yes | 0 | 25-Tap | 32 | 2 |

⁽¹⁾ Default

For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

10.3.4 DAC

The PCM3070 includes a stereo audio DAC supporting data rates from 8kHz to 192kHz. Each channel of the stereo audio DAC consists of a signal-processing engine with fixed processing blocks, a programmable miniDSP, a digital interpolation filter, multi-bit digital delta-sigma modulator, and an analog reconstruction filter. The DAC is designed to provide enhanced performance at low sampling rates through increased oversampling and image filtering, thereby keeping quantization noise generated within the delta-sigma modulator and signal images strongly suppressed within the audio band to beyond 20kHz. To handle multiple input rates and optimize performance, the PCM3070 allows the system designer to program the oversampling rates over a wide range from 1 to 1024. The system designer can choose higher oversampling ratios for lower input data rates and lower oversampling ratios for higher input data rates.

The PCM3070 DAC channel includes a built-in digital interpolation filter to generate oversampled data for the sigma-delta modulator. The interpolation filter can be chosen from three different types depending on required frequency response, group delay and sampling rate.

The DAC path of the PCM3070 features many options for signal conditioning and signal routing:

- · 2 headphone amplifiers
 - Usable in single-ended or differential mode
 - Analog volume setting with a range of -6 to +29dB
- 2 line-out amplifiers
 - Usable in single-ended or differential mode
 - Analog volume setting with a range of -6 to +29dB
- Digital volume control with a range of -63.5 to +24dB
- Mute function
- Dynamic range compression (DRC)



In addition to the standard set of DAC features the PCM3070 also offers the following special features:

- Built in sine wave generation (beep generator)
- · Digital auto mute
- Adaptive filter mode

10.3.4.1 DAC Processing Blocks — Overview

The PCM3070 implements signal processing capabilities and interpolation filtering via processing blocks. These fixed processing blocks give users the choice of how much and what type of signal processing they may use and which interpolation filter is applied.

Table 3 gives an overview over all available processing blocks of the DAC channel and their properties. The Resource Class Column (RC) gives an approximate indication of power consumption.

The signal processing blocks available are:

- First-order IIR
- · Scalable number of biquad filters
- 3D Effect
- Beep Generator

The processing blocks are tuned for typical cases and can achieve high image rejection or low group delay in combination with various signal processing effects such as audio effects and frequency shaping. The available first-order IIR and biquad filters have fully user-programmable coefficients. The Resource Class Column (RC) gives an approximate indication of power consumption.

Table 3. Overview - DAC Predefined Processing Blocks

| Processing Block No. | Interpolation Filter | Channel | 1st Order IIR Available | Num. of Biquads | DRC | 3D | Beep Generator |
|-------------------------|-------------------------|---------|----------------------------|--------------------|-----|-----|-------------------|
| PRB_P1 ⁽¹⁾ | A | Stereo | No | 3 | No | No | No |
| PRB_P2 | А | Stereo | Yes | 6 | Yes | No | No |
| PRB_P3 | А | Stereo | Yes | 6 | No | No | No |
| PRB_P4 | A | Left | No | 3 | No | No | No |
| PRB_P5 | A | Left | Yes | 6 | Yes | No | No |
| PRB_P6 | А | Left | Yes | 6 | No | No | No |
| PRB_P7 | В | Stereo | Yes | 0 | No | No | No |
| PRB_P8 | В | Stereo | No | 4 | Yes | No | No |
| PRB_P9 | В | Stereo | No | 4 | No | No | No |
| PRB_P10 | В | Stereo | Yes | 6 | Yes | No | No |
| PRB_P11 | В | Stereo | Yes | 6 | No | No | No |
| PRB_P12 | В | Left | Yes | 0 | No | No | No |
| PRB_P13 | В | Left | No | 4 | Yes | No | No |
| PRB_P14 | В | Left | No | 4 | No | No | No |
| PRB_P15 | В | Left | Yes | 6 | Yes | No | No |
| PRB_P16 | В | Left | Yes | 6 | No | No | No |
| PRB_P17 | С | Stereo | Yes | 0 | No | No | No |
| PRB_P18 | С | Stereo | Yes | 4 | Yes | No | No |
| PRB_P19 | С | Stereo | Yes | 4 | No | No | No |
| PRB_P20 | С | Left | Yes | 0 | No | No | No |
| PRB_P21 | С | Left | Yes | 4 | Yes | No | No |
| PRB_P22 | С | Left | Yes | 4 | No | No | No |
| PRB_P23 | А | Stereo | No | 2 | No | Yes | No |
| PRB_P24 | А | Stereo | Yes | 5 | Yes | Yes | No |
| PRB_P25 | А | Stereo | Yes | 5 | Yes | Yes | Yes |

(1) Default

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For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

10.3.5 Digital Audio IO Interface

Audio data is transferred between the host processor and the PCM3070 via the digital audio data serial interface, or audio bus. The audio bus on this device is very flexible, including left or right-justified data options, support for I2S or PCM protocols, programmable data length options, a TDM mode for multichannel operation, very flexible master/slave configurability for each bus clock line, and the ability to communicate with multiple devices within a system directly.

The audio bus of the PCM3070 can be configured for left or right-justified, I2S, DSP, or TDM modes of operation, where communication with standard PCM interfaces is supported within the TDM mode. These modes are all MSB-first, with data width programmable as 16, 20, 24, or 32 bits by configuring Page 0, Register 27, D(5:4). In addition, the word clock and bit clock can be independently configured in either Master or Slave mode, for flexible connectivity to a wide variety of processors. The word clock is used to define the beginning of a frame, and may be programmed as either a pulse or a square-wave signal. The frequency of this clock corresponds to the maximum of the selected ADC and DAC sampling frequencies.

The bit clock is used to clock in and clock out the digital audio data across the serial bus. When in Master mode, this signal can be programmed to generate variable clock pulses by controlling the bit-clock divider in Page 0, Register 30. The number of bit-clock pulses in a frame may need adjustment to accommodate various word-lengths as well as to support the case when multiple PCM3070s may share the same audio bus.

The PCM3070 also includes a feature to offset the position of start of data transfer with respect to the word-clock. This offset can be controlled in terms of number of bit-clocks and can be programmed in Page 0, Register 28.

The PCM3070 also has the feature of inverting the polarity of the bit-clock used for transferring the audio data as compared to the default clock polarity used. This feature can be used independently of the mode of audio interface chosen. This can be configured via Page 0, Register 29, D(3).

The PCM3070 further includes programmability (Page 0, Register 27, D0) to place the DOUT line into a hi-Z (3-state) condition during all bit clocks when valid data is not being sent. By combining this capability with the ability to program at what bit clock in a frame the audio data begins, time-division multiplexing (TDM) can be accomplished, enabling the use of multiple codecs on a single audio serial data bus. When the audio serial data bus is powered down while configured in master mode, the pins associated with the interface are put into a hi-Z output condition.

By default when the word-clocks and bit-clocks are generated by the PCM3070, these clocks are active only when the codec (ADC, DAC or both) are powered up within the device. This is done to save power. However, it also supports a feature when both the word clocks and bit-clocks can be active even when the codec in the device is powered down. This is useful when using the TDM mode with multiple codecs on the same bus, or when word-clock or bit-clocks are used in the system as general-purpose clocks.

10.3.6 Clock Generation and PLL

The PCM3070 supports a wide range of options for generating clocks for the ADC and DAC sections as well as interface and other control blocks. The clocks for ADC and DAC require a source reference clock. This clock can be provided on variety of device pins such as MCLK, BCLK or GPI pins. The CODEC_CLKIN can then be routed through highly-flexible clock dividers to generate the various clocks required for ADC, DAC and the miniDSP sections. In the event that the desired audio or miniDSP clocks cannot be generated from the reference clocks on MCLK BCLK or GPIO, the PCM3070 also provides the option of using the on-chip PLL which supports a wide range of fractional multiplication values to generate the required clocks. Starting from CODEC_CLKIN the PCM3070 provides several programmable clock dividers to help achieve a variety of sampling rates for ADC, DAC and clocks for the miniDSP.

For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

10.3.7 Control Interfaces

The PCM3070 control interface supports SPI or I²C communication protocols, with the protocol selectable using the SPI_SELECT pin. For SPI, SPI_SELECT should be tied high; for I²C, SPI_SELECT should be tied low. Changing the state of SPI_SELECT during device operation is not recommended.



10.3.7.1 PC Control

The PCM3070 supports the I²C control protocol, and will respond to the I²C address of 0011000. I²C is a two-wire, open-drain interface supporting multiple devices and masters on a single bus. Devices on the I²C bus only drive the bus lines LOW by connecting them to ground; they never drive the bus lines HIGH. Instead, the bus wires are pulled HIGH by pullup resistors, so the bus wires are HIGH when no device is driving them LOW. This circuit prevents two devices from conflicting; if two devices drive the bus simultaneously, there is no driver contention.

10.3.7.2 SPI Control

In the SPI control mode, the PCM3070 uses the pins SCL/SS as SS, SCLK as SCLK, MISO as MISO, SDA/MOSI as MOSI; a standard SPI port with clock polarity setting of 0 (typical microprocessor SPI control bit CPOL = 0). The SPI port allows full-duplex, synchronous, serial communication between a host processor (the master) and peripheral devices (slaves). The SPI master (in this case, the host processor) generates the synchronizing clock (driven onto SCLK) and initiates transmissions. The SPI slave devices (such as the PCM3070) depend on a master to start and synchronize transmissions. A transmission begins when initiated by an SPI master. The byte from the SPI master begins shifting in on the slave MOSI pin under the control of the master serial clock (driven onto SCLK). As the byte shifts in on the MOSI pin, a byte shifts out on the MISO pin to the master shift register.

For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

10.4 Device Functional Modes

The following special functions are available to support advanced system requirements:

- Interrupt generation
- Flexible pin multiplexing

For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

10.4.1 MiniDSP

The PCM3070 features two miniDSP cores. The first miniDSP core is tightly coupled to the ADC, the second miniDSP core is tightly coupled to the DAC. The fully programmable algorithms for the miniDSP must be loaded into the device after power up. The miniDSPs have direct access to the digital stereo audio stream on the ADC and on the DAC side, offering the possibility for advanced, very-low group delay DSP algorithms. Each miniDSP can run up to 1152 instructions on every audio sample at a 48kHz sample rate. The two cores can run fully synchronized and can exchange data.

10.4.2 Software

Software development for the PCM3070 is supported through TI's comprehensive PurePath Studio Development Environment; a powerful, easy-to-use tool designed specifically to simplify software development on the PCM3070 miniDSP audio platform. The Graphical Development Environment consists of a library of common audio functions that can be dragged-and-dropped into an audio signal flow and graphically connected together. The DSP code can then be assembled from the graphical signal flow with the click of a mouse.

Please visit the PCM3070 product folder on www.ti.com to learn more about PurePath Studio and the latest status on available, ready-to-use DSP algorithms.



10.5 Register Map

10.5.1 Register Map Summary

Table 4. Summary of Register Map

| Decimal | | Hex | | DESCRIPTION | | |
|----------|----------|----------|-----------|---|--|--|
| PAGE NO. | REG. NO. | PAGE NO. | REG. NO. | | | |
| 0 | 0 | 0x00 | 0x00 | Page Select Register | | |
| 0 | 1 | 0x00 | 0x01 | Software Reset Register | | |
| 0 | 2 | 0x00 | 0x02 | Reserved Register | | |
| 0 | 3 | 0x00 | 0x03 | Reserved Register | | |
| 0 | 4 | 0x00 | 0x04 | Clock Setting Register 1, Multiplexers | | |
| 0 | 5 | 0x00 | 0x05 | Clock Setting Register 2, PLL P&R Values | | |
| 0 | 6 | 0x00 | 0x06 | Clock Setting Register 3, PLL J Values | | |
| 0 | 7 | 0x00 | 0x07 | Clock Setting Register 4, PLL D Values (MSB) | | |
| 0 | 8 | 0x00 | 0x08 | Clock Setting Register 5, PLL D Values (LSB) | | |
| 0 | 9-10 | 0x00 | 0x09-0x0A | Reserved Register | | |
| 0 | 11 | 0x00 | 0x0B | Clock Setting Register 6, NDAC Values | | |
| 0 | 12 | 0x00 | 0x0C | Clock Setting Register 7, MDAC Values | | |
| 0 | 13 | 0x00 | 0x0D | DAC OSR Setting Register 1, MSB Value | | |
| 0 | 14 | 0x00 | 0x0E | DAC OSR Setting Register 2, LSB Value | | |
| 0 | 15 | 0x00 | 0x0F | miniDSP_D Instruction Control Register 1 | | |
| 0 | 16 | 0x00 | 0x10 | miniDSP_D Instruction Control Register 2 | | |
| 0 | 17 | 0x00 | 0x11 | miniDSP_D Interpolation Factor Setting Register | | |
| 0 | 18 | 0x00 | 0x12 | Clock Setting Register 8, NADC Values | | |
| 0 | 19 | 0x00 | 0x13 | Clock Setting Register 9, MADC Values | | |
| 0 | 20 | 0x00 | 0x14 | ADC Oversampling (AOSR) Register | | |
| 0 | 21 | 0x00 | 0x15 | miniDSP_A Instruction Control Register 1 | | |
| 0 | 22 | 0x00 | 0x16 | miniDSP_A Instruction Control Register 2 | | |
| 0 | 23 | 0x00 | 0x17 | miniDSP_A Decimation Factor Setting Register | | |
| 0 | 24 | 0x00 | 0x18 | Reserved Register | | |
| 0 | 25 | 0x00 | 0x19 | Clock Setting Register 10, Multiplexers | | |
| 0 | 26 | 0x00 | 0x1A | Clock Setting Register 11, CLKOUT M divider value | | |
| 0 | 27 | 0x00 | 0x1B | Audio Interface Setting Register 1 | | |
| 0 | 28 | 0x00 | 0x1C | Audio Interface Setting Register 2, Data offset setting | | |
| 0 | 29 | 0x00 | 0x1D | Audio Interface Setting Register 3 | | |
| 0 | 30 | 0x00 | 0x1E | Clock Setting Register 12, BCLK N Divider | | |
| 0 | 31 | 0x00 | 0x1F | Audio Interface Setting Register 4, Secondary Audio Interface | | |
| 0 | 32 | 0x00 | 0x20 | Audio Interface Setting Register 5 | | |
| 0 | 33 | 0x00 | 0x21 | Audio Interface Setting Register 6 | | |
| 0 | 34 | 0x00 | 0x22 | Digital Interface Misc. Setting Register | | |
| 0 | 35 | 0x00 | 0x23 | Reserved Register | | |
| 0 | 36 | 0x00 | 0x24 | ADC Flag Register | | |
| 0 | 37 | 0x00 | 0x25 | DAC Flag Register 1 | | |
| 0 | 38 | 0x00 | 0x26 | DAC Flag Register 2 | | |
| 0 | 39-41 | 0x00 | 0x27-0x29 | Reserved Register | | |
| 0 | 42 | 0x00 | 0x2A | Sticky Flag Register 1 | | |
| 0 | 43 | 0x00 | 0x2B | Interrupt Flag Register 1 | | |
| 0 | 44 | 0x00 | 0x2C | Sticky Flag Register 2 | | |
| 0 | 45 | 0x00 | 0x2D | Sticky Flag Register 3 | | |



Register Map (continued)

Table 4. Summary of Register Map (continued)

| | | | DESCRIPTION | |
|-------------------|-----------------|----------|--------------|---|
| PAGE NO. REG. NO. | | | | DESCRIPTION |
| 0 | REG. NO. | PAGE NO. | REG. NO. | Interrupt Flog Pogistor 2 |
| - | 47 | 0x00 | 0x2E 0x2F | Interrupt Flag Register 2 |
| 0 | 48 | 0x00 | | Interrupt Flag Register 3 INT1 Interrupt Control Register |
| - | | | 0x30 | |
| 0 | 49 | 0x00 | 0x31 | INT2 Interrupt Control Register |
| 0 | 50-51 | 0x00 | 0x32-0x33 | Reserved Register |
| 0 | 52 | 0x00 | 0x34 | GPIO/MFP5 Control Register |
| 0 | 53 | 0x00 | 0x35 | DOUT/MFP2 Function Control Register |
| 0 | 54 | 0x00 | 0x36 | DIN/MFP1 Function Control Register |
| 0 | 55 | 0x00 | 0x37 | MISO/MFP4 Function Control Register |
| 0 | 56 | 0x00 | 0x38 | SCLK/MFP3 Function Control Register |
| 0 | 57-59 | 0x00 | 0x39-0x3B | Reserved Registers |
| 0 | 60 | 0x00 | 0x3C | DAC Signal Processing Block Control Register |
| 0 | 61 | 0x00 | 0x3D | ADC Signal Processing Block Control Register |
| 0 | 62 | 0x00 | 0x3E | miniDSP_A and miniDSP_D Configuration Register |
| 0 | 63 | 0x00 | 0x3F | DAC Channel Setup Register 1 |
| 0 | 64 | 0x00 | 0x40 | DAC Channel Setup Register 2 |
| 0 | 65 | 0x00 | 0x41 | Left DAC Channel Digital Volume Control Register |
| 0 | 66 | 0x00 | 0x42 | Right DAC Channel Digital Volume Control Register |
| 0 | 67 | 0x00 | 0x43 | Headset Detection Configuration Register |
| 0 | 68 | 0x00 | 0x44 | DRC Control Register 1 |
| 0 | 69 | 0x00 | 0x45 | DRC Control Register 2 |
| 0 | 70 | 0x00 | 0x46 | DRC Control Register 3 |
| 0 | 71 | 0x00 | 0x47 | Beep Generator Register 1 |
| 0 | 72 | 0x00 | 0x48 | Beep Generator Register 2 |
| 0 | 73 | 0x00 | 0x49 | Beep Generator Register 3 |
| 0 | 74 | 0x00 | 0x4A | Beep Generator Register 4 |
| 0 | 75 | 0x00 | 0x4B | Beep Generator Register 5 |
| 0 | 76 | 0x00 | 0x4C | Beep Generator Register 6 |
| 0 | 77 | 0x00 | 0x4D | Beep Generator Register 7 |
| 0 | 78 | 0x00 | 0x4E | Beep Generator Register 8 |
| 0 | 79 | 0x00 | 0x4F | Beep Generator Register 9 |
| 0 | 80 | 0x00 | 0x50 | Reserved Register |
| 0 | 81 | 0x00 | 0x51 | ADC Channel Setup Register |
| 0 | 82 | 0x00 | 0x52 | ADC Fine Gain Adjust Register |
| 0 | 83 | 0x00 | 0x53 | Left ADC Channel Volume Control Register |
| 0 | 84 | 0x00 | 0x54 | Right ADC Channel Volume Control Register |
| 0 | 85 | 0x00 | 0x55 | ADC Phase Adjust Register |
| 0 | 86 | 0x00 | 0x56 | Left Channel AGC Control Register 1 |
| 0 | 87 | 0x00 | 0x57 | Left Channel AGC Control Register 2 |
| 0 | 88 | 0x00 | 0x58 | Left Channel AGC Control Register 3 |
| 0 | 89 | 0x00 | 0x59 | Left Channel AGC Control Register 4 |
| 0 | 90 | 0x00 | 0x5A | Left Channel AGC Control Register 5 |
| 0 | 91 | 0x00 | 0x5B | Left Channel AGC Control Register 6 |
| 0 | 92 | 0x00 | 0x5C | Left Channel AGC Control Register 7 |
| 0 | 93 | 0x00 | 0x5D | Left Channel AGC Control Register 8 |



Register Map (continued)

Table 4. Summary of Register Map (continued)

| PAGE NO. PAGE NO. PAGE NO. Ox5E Right Channel AGC Control Register 1 | Decimal | | н | ex | DESCRIPTION |
|--|---------|-------|------|-----------|--|
| 0 94 0x00 0x5E Right Channel AGC Control Register 1 0 95 0x00 0x6F Right Channel AGC Control Register 2 0 96 0x00 0x60 Right Channel AGC Control Register 3 0 97 0x00 0x61 Right Channel AGC Control Register 4 0 98 0x00 0x62 Right Channel AGC Control Register 6 0 99 0x00 0x63 Right Channel AGC Control Register 7 0 101 0x00 0x66 Right Channel AGC Control Register 7 0 101 0x00 0x66 Right Channel AGC Control Register 7 0 101 0x00 0x66 DC Measurement Register 1 0 103 0x00 0x67 DC Measurement Register 2 0 104 0x00 0x68 Left Channel DC Measurement Output Register 1 0 105 0x00 0x68 Right Channel DC Measurement Output Register 2 0 106 0x00 0x66 Right Channel DC Measurement Output Register 3 | | | | T | |
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| 1 25 0x01 0x19 Mixer Amplifier Right Volume Control Register 1 26-50 0x01 0x1A-0x32 Reserved Register 1 51 0x01 0x33 Reserved. Do Not Use 1 52 0x01 0x34 Left PGA Positive Terminal Input Routing Configuration Register | 1 | 24 | 0x01 | 0x18 | Mixer Amplifier Left Volume Control Register |
| 1 26-50 0x01 0x1A-0x32 Reserved Register 1 51 0x01 0x33 Reserved. Do Not Use 1 52 0x01 0x34 Left PGA Positive Terminal Input Routing Configuration Register | 1 | 25 | 0x01 | 0x19 | |
| 1 51 0x01 0x33 Reserved. Do Not Use 1 52 0x01 0x34 Left PGA Positive Terminal Input Routing Configuration Register | 1 | 26-50 | 0x01 | 0x1A-0x32 | |
| | 1 | 51 | 0x01 | 0x33 | |
| | 1 | 52 | 0x01 | 0x34 | Left PGA Positive Terminal Input Routing Configuration Register |
| . The state of the | 1 | 53 | 0x01 | 0x35 | Reserved Register |
| 1 54 0x01 0x36 Left PGA Negative Terminal Input Routing Configuration Register | 1 | | 0x01 | 0x36 | |



Register Map (continued)

Table 4. Summary of Register Map (continued)

| Decimal | | Н | ex | DESCRIPTION | | |
|-------------------|---------|-------------------|-----------|--|--|--|
| PAGE NO. REG. NO. | | PAGE NO. REG. NO. | | | | |
| 1 | 55 | 0x01 | 0x37 | Right PGA Positive Terminal Input Routing Configuration Register | | |
| 1 | 56 | 0x01 | 0x38 | Reserved Register | | |
| 1 | 57 | 0x01 | 0x39 | Right PGA Negative Terminal Input Routing Configuration Register | | |
| 1 | 58 | 0x01 | 0x3A | Floating Input Configuration Register | | |
| 1 | 59 | 0x01 | 0x3B | Left PGA Volume Control Register | | |
| 1 | 60 | 0x01 | 0x3C | Right PGA Volume Control Register | | |
| 1 | 61 | 0x01 | 0x3D | Reserved. Do Not Use | | |
| 1 | 62 | 0x01 | 0x3E | ADC Analog Volume Control Flag Register | | |
| 1 | 63 | 0x01 | 0x3F | DAC Analog Gain Control Flag Register | | |
| 1 | 64-70 | 0x01 | 0x40-0x46 | Reserved Register | | |
| 1 | 71 | 0x01 | 0x47 | Analog Input Quick Charging Configuration Register | | |
| 1 | 72-122 | 0x01 | 0x48-0x7A | Reserved Register | | |
| 1 | 123 | 0x01 | 0x7B | Reference Power-up Configuration Register | | |
| 1 | 124-127 | 0x01 | 0x7C-0x7F | Reserved Register | | |
| 8 | 0 | 0x08 | 0x00 | Page Select Register | | |
| 8 | 1 | 0x08 | 0x01 | ADC Adaptive Filter Configuration Register | | |
| 8 | 2-7 | 0x08 | 0x02-0x07 | Reserved | | |
| 8 | 8-127 | 0x08 | 0x08-0x7F | ADC Coefficients Buffer-A C(0:29) | | |
| 9-16 | 0 | 0x09-0x10 | 0x00 | Page Select Register | | |
| 9-16 | 1-7 | 0x09-0x10 | 0x01-0x07 | Reserved | | |
| 9-16 | 8-127 | 0x09-0x10 | 0x08-0x7F | ADC Coefficients Buffer-A C(30:255) | | |
| 26-34 | 0 | 0x1A-0x22 | 0x00 | Page Select Register | | |
| 26-34 | 1-7 | 0x1A-0x22 | 0x01-0x07 | Reserved. | | |
| 26-34 | 8-127 | 0x1A-0x22 | 0x08-0x7F | ADC Coefficients Buffer-B C(0:255) | | |
| 44 | 0 | 0x2C | 0x00 | Page Select Register | | |
| 44 | 1 | 0x2C | 0x01 | DAC Adaptive Filter Configuration Register | | |
| 44 | 2-7 | 0x2C | 0x02-0x07 | Reserved | | |
| 44 | 8-127 | 0x2C | 0x08-0x7F | DAC Coefficients Buffer-A C(0:29) | | |
| 45-52 | 0 | 0x2D-0x34 | 0x00 | Page Select Register | | |
| 45-52 | 1-7 | 0x2D-0x34 | 0x01-0x07 | Reserved. | | |
| 45-52 | 8-127 | 0x2D-0x34 | 0x08-0x7F | DAC Coefficients Buffer-A C(30:255) | | |
| 62-70 | 0 | 0x3E-0x46 | 0x00 | Page Select Register | | |
| 62-70 | 1-7 | 0x3E-0x46 | 0x01-0x07 | Reserved. | | |
| 62-70 | 8-127 | 0x3E-0x46 | 0x08-0x7F | DAC Coefficients Buffer-B C(0:255) | | |
| 80-114 | 0 | 0x50-0x72 | 0x00 | Page Select Register | | |
| 80-114 | 1-7 | 0x50-0x72 | 0x01-0x07 | Reserved. | | |
| 80-114 | 8-127 | 0x50-0x72 | 0x08-0x7F | miniDSP_A Instructions | | |
| 152-186 | 0 | 0x98-0xBA | 0x00 | Page Select Register | | |
| 152-186 | 1-7 | 0x98-0xBA | 0x01-0x07 | Reserved. | | |
| 152-186 | 8-127 | 0x98-0xBA | 0x08-0x7F | miniDSP_D Instructions | | |



11 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

11.1 Application Information

The PCM3070 is a highly integrated stereo audio codec with integrated miniDSP and flexible digital audio interface options. It enables many different types of audio platforms having a need for stereo audio record and playback and needing to interface with other devices in the system over a digital audio interface.

11.2 Typical Application

Figure 19 shows a typical circuit configuration for a system using the PCM3070.

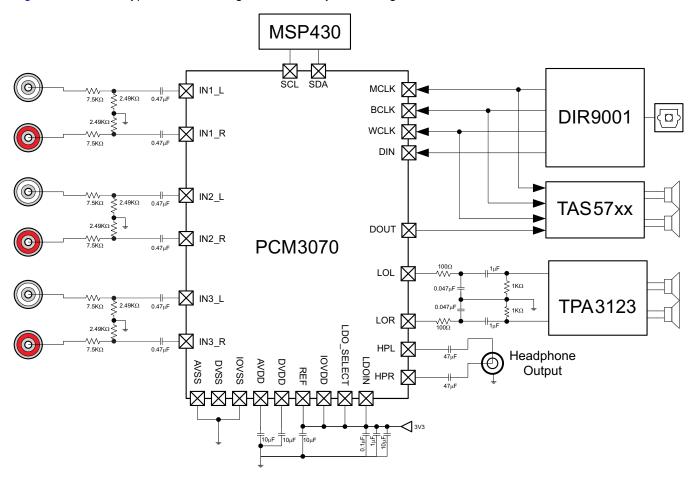


Figure 19. Typical Circuit Configuration



Typical Application (continued)

11.2.1 Design Requirements

11.2.1.1 Reference Filtering Capacitor

The PCM3070 has a built-in bandgap used to generate reference voltages and currents for the device. To achieve high SNR, the reference voltage on REF should be filtered using a 10-µF capacitor from REF terminal to ground.

11.2.2 Detailed Design Procedures

11.2.2.1 Analog Input Connection

The analog inputs to PCM3070 should be ac-coupled to the device terminals to allow decoupling of signal source's common mode voltage with that of PCM3070's common mode voltage. The input coupling capacitor in combination with the selected input impedance of PCM3070 forms a high-pass filter.

$$F_c = 1/(2 \times \pi \times R_{e0}C_c)$$
 (1)

$$C_c = 1/(2 \times \pi \times R_{eq} F_c)$$
 (2)

For high fidelity audio recording application it is desirable to keep the cutoff frequency of the high pass filter as low as possible. For single-ended input mode, the equivalent input resistance R_{eq} can be calculated as

$$R_{eq} = R_{in} \times (1 + 2g)/(1+g) \tag{3}$$

where g is the analog PGA gain calculated in linear terms.

$$q = 10000 \times 2^{floor(G/6)}/R_{in}$$
(4)

where G is the analog PGA gain programmed in P1_R59-R60 (in dB) and R_{in} is the value of the resistor programmed in P1_R52-R57 and assumes $R_{in} = R_{cm}$ (as defined in P1_R52-R57).

For differential input mode, R_{eq} of the half circuit can be calculated as:

$$R_{eq} = R_{in} \tag{5}$$

where R_{in} is the value of the resistor programmed in P1_R52-R57, assuming symmetrical inputs.

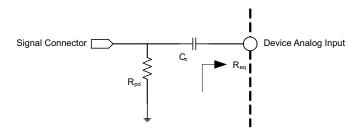


Figure 20. Analog Input Connection With Pull-down Resistor

When the analog signal is connected to the system through a connector such as audio jack, it is recommended to put a pull-down resistor on the signal as shown in Figure 20. The pulldown resistor helps keep the signal grounded and helps improve noise immunity when no source is connected to the connector. The pulldown resistor value should be chosen large enough to avoid loading of signal source.

Each analog input of the PCM3070 is capable of handling signal amplitude of 0.5 Vrms. If the input signal source can drive signals higher than the maximum value, an external resistor divider network as shown in Figure 21 should be used to attenuate the signal to less than 0.5Vrms before connecting the signal to the device. The resistor values of the network should be chosen to provide desired attenuation as well as Equation 6.

$$R_1 || R_2 << R_{eq} \tag{6}$$



Typical Application (continued)

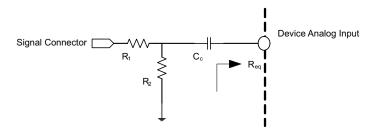


Figure 21. Analog Input Connection With Resistor Divider Network

Whenever any of the analog input terminals IN1_L, IN2_L, IN3_L, IN1_R, IN2_R or IN3_R are not used in an application, it is recommended to short the unused input terminals together (if convenient) and connect them to ground using a small capacitor (example $0.1 \mu F$).

11.2.2.2 Analog Output Connection

The line outputs of the PCM3070 drive a signal biased around the device common mode voltage. To avoid loading the common mode with the load, it is recommended to connect the single-ended load through an accoupling capacitor. The ac-coupling capacitor in combination with the load impedance forms a high pass filter.

$$F_{c} = 1/(2 \times \pi \times R_{L}C_{c}) \tag{7}$$

 $C_c = 1/(2 \times \pi \times R_L F_c)$ (8)

For high fidelity playback, the cutoff frequency of the resultant high-pass filter should be kept low. For example with R_L of 10 k Ω , using 1- μ F coupling capacitor results in a cut-off frequency of 8 Hz.

For differential lineout configurations, the load should be directly connected between the differential outputs, with no coupling capacitor.

Whenever any of the analog output terminals LOL, LOR, HPL or HPR are not used in an application, they should be left open or not connected.



Typical Application (continued)

11.2.3 Application Curves

Figure 22 shows the excellent low-distortion performance of the PCM3070 in a system over the 20-Hz to 20-kHz audio spectrum.

Figure 23 shows the distortion performance of the PCM3070 in a system over the input amplitude range.

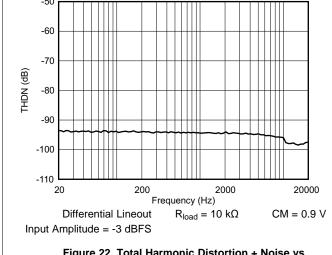


Figure 22. Total Harmonic Distortion + Noise vs Input Frequency

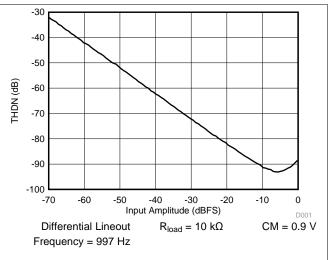


Figure 23. Total Harmonic Distortion + Noise vs Input Amplitude

iomit Documentation Feedback



12 Power Supply Recommendations

To power up the device, a 3.3V system rail (1.9V to 3.6V) can be used. The IOVDD voltage can be in the range of 1.1V - 3.6V. Internal LDOs can generate the appropriate digital and analog core voltages when configured to do so. For maximum flexibility, the respective voltages can also be supplied externally, bypassing the built-in LDOs. To support high-output drive capabilities, the output stages of the output amplifiers can be driven from the analog core voltage or the 1.9...3.6V rail used for the LDO inputs (LDO_in).

The AVDD and LDOIN power inputs are used to power the analog circuits including analog to digital converters, digital to analog converters, programmable gain amplifiers, headphone amplifiers, etc. The analog blocks in PCM3070 have high power supply rejection ratio, however it is recommended that these supplies be powered by well regulated power supplies like low dropout regulators (LDO) for optimal performance. When these power terminals are driven from a common power source, the current drawn from the source will depend upon blocks enabled inside the device. However as an example when all the internal blocks powered are enabled the source should be able to deliver 150mA of current.

The DVDD powers the digital core of PCM3070, including the miniDSP, the audio serial interface, control interfaces (SPI or I2C), clock generation and PLL. The DVDD power can be driven by high efficiency switching regulators or low drop out regulators. When the miniDSP_A and miniDSP_D are enabled in programmable mode and operated at peak frequencies, the supply source should be able to able to deliver approx 100mA of current. When the PRB modes are used instead of programmable miniDSP mode, then the peak current load on DVDD supply source could be approximately 20 mA.

The IOVDD powers the digital input and digital output buffers of PCM3070. The current consumption of this power depends on configuration of digital terminals as inputs or outputs. When the digital terminals are configured as outputs, the current consumption would depend on switching frequency of the signal and the load on the output terminal, which depends on board design and input capacitance of other devices connected to the signal.

Refer to Figure 19 for recommendations on decoupling capacitors.

For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

13 Layout

13.1 Layout Guidelines

Each system design and PCB layout is unique. The layout should be carefully reviewed in the context of a specific PCB design. However, the following guidelines can optimize PCM3070 performance:

- Connect the thermal pad to ground.
- The decoupling capacitors for the power supplies should be placed close to the device terminals. Figure 19 shows the recommended decoupling capacitors for the PCM3070.
- The PCM3070 internal voltage references must be filtered using external capacitors. Place the filter capacitors on REF near the device terminals for optimal performance.
- For analog differential audio signals, the signals should be routed differentially on the PCB for better noise immunity. Avoid crossing of digital and analog signals to avoid undesirable crosstalk.



13.2 Layout Example

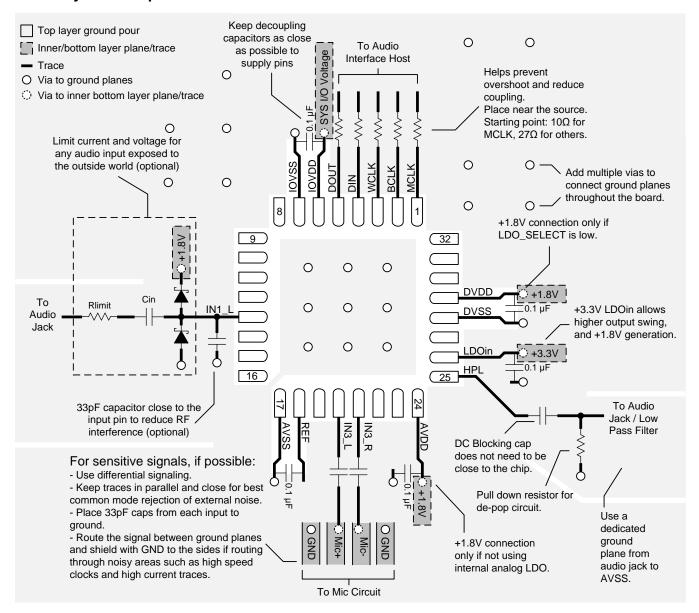


Figure 24. Layout

Product Folder Links: PCM3070

Example layout views can be found in the EVM User Guide:

http://www.ti.com/tool/PCM3070RHBEVM-K

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14 Device and Documentation Support

14.1 Documentation Support

14.1.1 Related Documentation

PCM3070 Application Reference Guide, SLAU332.

14.2 Trademarks

All trademarks are the property of their respective owners.

14.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

14.4 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

15 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

www.ti.com

17-Jun-2025

PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package Pins | Package qty Carrier | RoHS | Lead finish/ Ball material | MSL rating/ Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|--------|---------------|-----------------|-----------------------|------|-------------------------------|----------------------------|--------------|------------------|
| PCM3070IRHBR | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | (5) Level-1-260C-UNLIM | -40 to 85 | PCM3070 |
| PCM3070IRHBR.A | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | PCM3070 I |
| PCM3070IRHBT | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | PCM3070 I |
| PCM3070IRHBT.A | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | PCM3070 I |
| PCM3070IRHBTG4 | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | PCM3070 I |
| PCM3070IRHBTG4.A | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | PCM3070 I |

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



PACKAGE OPTION ADDENDUM

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| PCM3070IRHBR | VQFN | RHB | 32 | 3000 | 330.0 | 12.4 | 5.3 | 5.3 | 1.1 | 8.0 | 12.0 | Q2 |
| PCM3070IRHBT | VQFN | RHB | 32 | 250 | 180.0 | 12.4 | 5.3 | 5.3 | 1.1 | 8.0 | 12.0 | Q2 |
| PCM3070IRHBTG4 | VQFN | RHB | 32 | 250 | 180.0 | 12.4 | 5.3 | 5.3 | 1.1 | 8.0 | 12.0 | Q2 |

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| PCM3070IRHBR | VQFN | RHB | 32 | 3000 | 346.0 | 346.0 | 33.0 |
| PCM3070IRHBT | VQFN | RHB | 32 | 250 | 210.0 | 185.0 | 35.0 |
| PCM3070IRHBTG4 | VQFN | RHB | 32 | 250 | 210.0 | 185.0 | 35.0 |

5 x 5, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



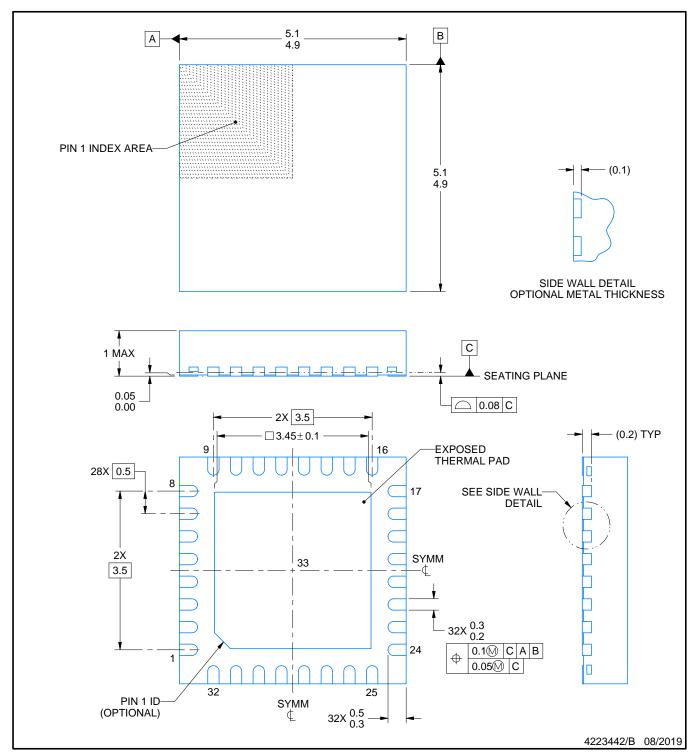
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4224745/A





PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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